

## 60V N-Channel Enhancement Mode Power MOSFET

### Description

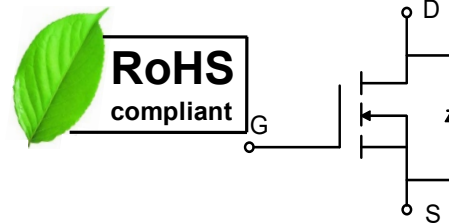
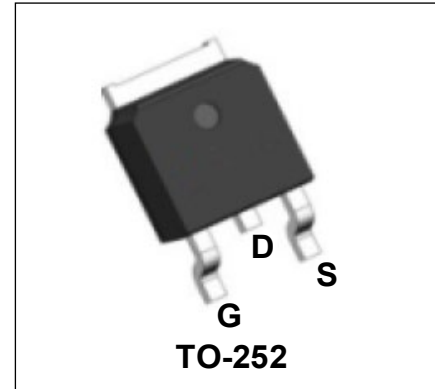
WMO80N06T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

### Features

- $V_{DS} = 60V$ ,  $I_D = 80A$   
 $R_{DS(on)} < 7.2m\Omega @ V_{GS} = 10V$
- Green Device Available
- Low Gate Charge
- Low  $R_{DS(on)}$
- 100% EAS Guaranteed

### Applications

- Synchronous Rectification
- DC/DC Converter
- Moto Control



### Absolute Maximum Ratings

Parameter		Symbol	Value	Unit
Drain-Source Voltage		$V_{DS}$	60	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>1</sup>	$T_C = 25^\circ C$	$I_D$	80	A
	$T_C = 100^\circ C$		50.6	
Pulsed Drain Current <sup>2</sup>		$I_{DM}$	320	A
Single Pulse Avalanche Energy <sup>3</sup>		<b>EAS</b>	80	mJ
Total Power Dissipation <sup>4</sup>	$T_C = 25^\circ C$	$P_D$	96.1	W
Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-55 to 150	$^\circ C$

### Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Case <sup>1</sup>	$R_{\theta JC}$	1.3	$^\circ C/W$

**Electrical Characteristics** T<sub>c</sub> = 25°C, unless otherwise noted

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	<b>V<sub>(BR)DSS</sub></b>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	60	-	-	V
Gate-body Leakage current	<b>I<sub>GSS</sub></b>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	<b>I<sub>DSS</sub></b>	T <sub>J</sub> =25°C V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V	-	-	1	μA
Gate-Threshold Voltage	<b>V<sub>GS(th)</sub></b>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2	3	4	V
Drain-Source on-Resistance <sup>2</sup>	<b>R<sub>DS(on)</sub></b>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	5.5	7.2	mΩ
Forward Transconductance <sup>2</sup>	<b>g<sub>fs</sub></b>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 20A	-	25	-	S
<b>Dynamic Characteristics</b>						
Input Capacitance	<b>C<sub>iss</sub></b>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz	-	3692	-	pF
Output Capacitance	<b>C<sub>oss</sub></b>		-	263.2	-	
Reverse Transfer Capacitance	<b>C<sub>rss</sub></b>		-	218	-	
<b>Switching Characteristics</b>						
Gate Resistance	<b>R<sub>g</sub></b>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz	-	0.7	-	Ω
Total Gate Charge	<b>Q<sub>g</sub></b>	V <sub>GS</sub> = 10, V <sub>DS</sub> = 30V, I <sub>D</sub> =20A	-	80	-	nC
Gate-Source Charge	<b>Q<sub>gs</sub></b>		-	7.2	-	
Gate-Drain Charge	<b>Q<sub>gd</sub></b>		-	15.5	-	
Turn-on Delay Time	<b>t<sub>d(on)</sub></b>	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 30V, R <sub>G</sub> = 3Ω, R <sub>L</sub> = 1Ω, I <sub>D</sub> = 20A	-	7.5	-	ns
Rise Time	<b>t<sub>r</sub></b>		-	6.2	-	
Turn-off Delay Time	<b>t<sub>d(off)</sub></b>		-	34	-	
Fall Time	<b>t<sub>f</sub></b>		-	12.8	-	
<b>Drain-Source Body Diode Characteristics</b>						
Diode Forward Voltage <sup>2</sup>	<b>V<sub>SD</sub></b>	I <sub>S</sub> = 1A, V <sub>GS</sub> = 0V	-	-	1	V
Continuous Source Current <sup>1,5</sup>	<b>I<sub>S</sub></b>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	-	-	80	A
Body Diode Reverse Recovery Time	<b>t<sub>rr</sub></b>	I <sub>F</sub> = 20A, dI/dt = 100A/μs	-	38	-	ns
Body Diode Reverse Recovery Charge	<b>Q<sub>rr</sub></b>		-	53	-	nC

## Notes:

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
3. The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=30V, L=0.1mH, I<sub>AS</sub>=40A
4. The power dissipation is limited by 150°C junction temperature
5. The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub> , in real applications , should be limited by total power dissipation.

Typical Characteristics

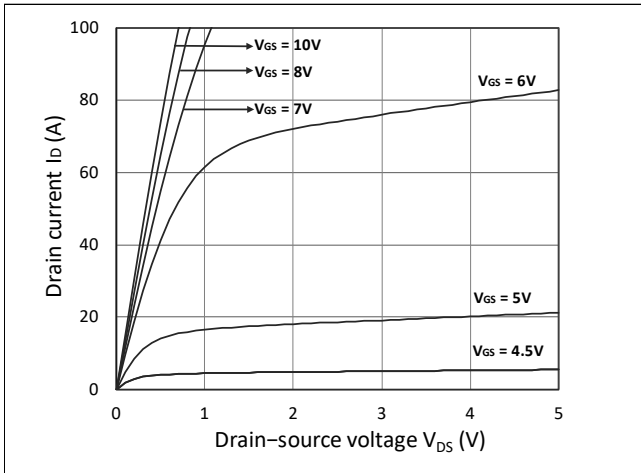


Figure 1. Output Characteristics

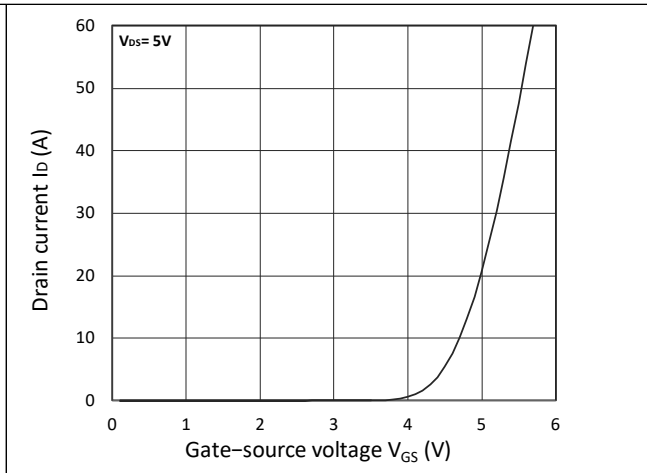


Figure 2. Transfer Characteristics

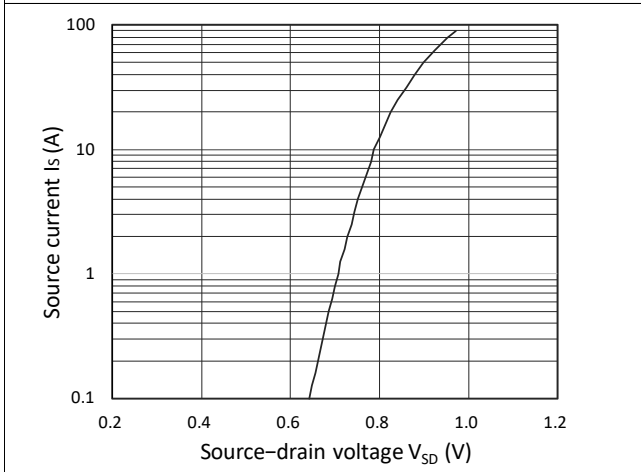


Figure 3. Forward Characteristics of Reverse

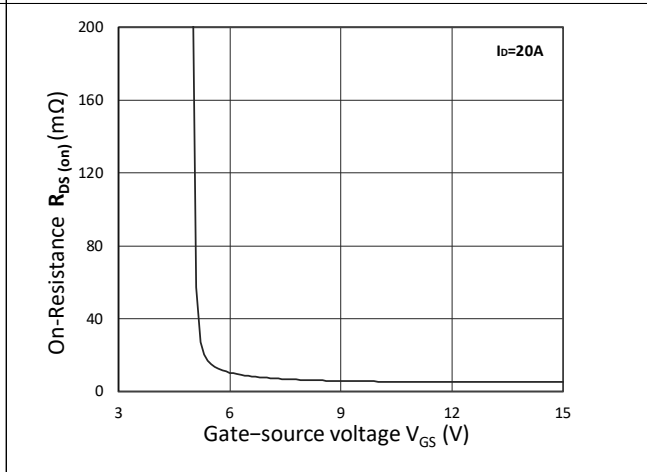


Figure 4.  $R_{DS(on)}$  vs.  $V_{GS}$

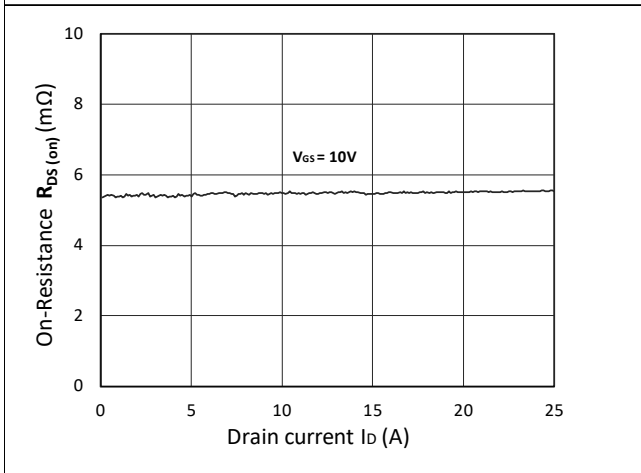


Figure 5.  $R_{DS(on)}$  vs.  $I_D$

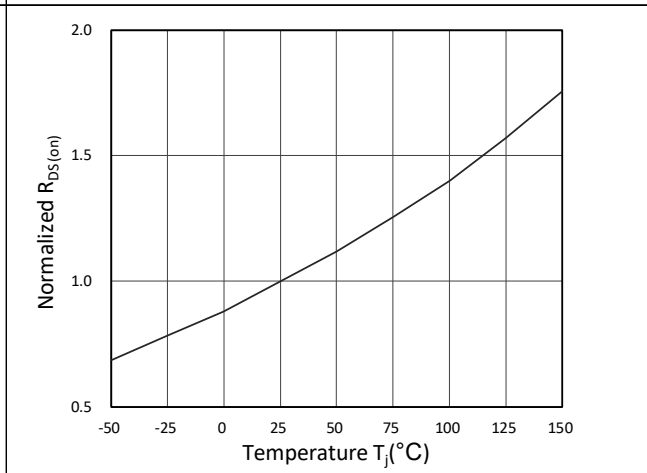


Figure 6. Normalized  $R_{DS(on)}$  vs. Temperature

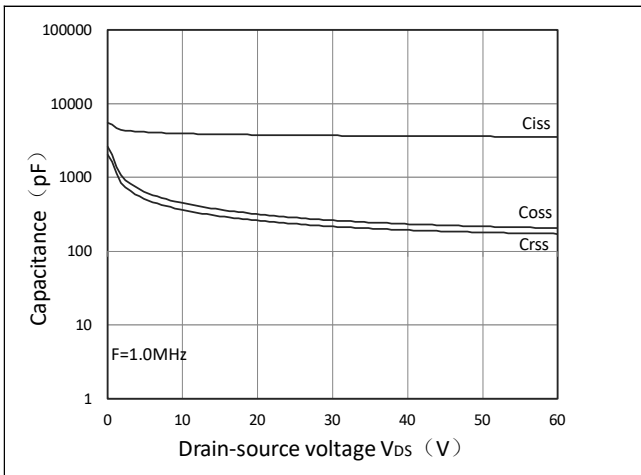


Figure 7. Capacitance Characteristics

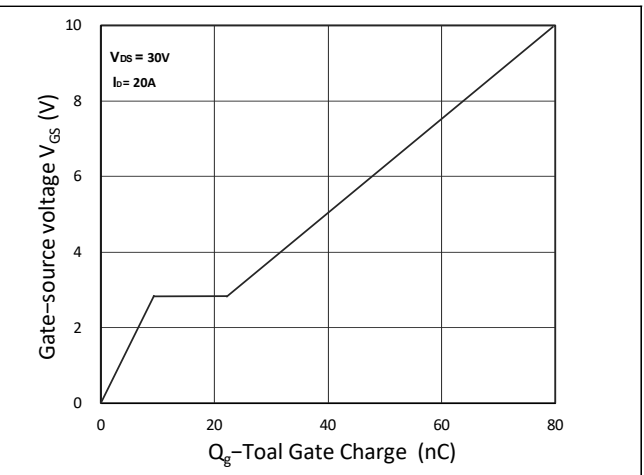


Figure 8. Gate Charge Characteristics

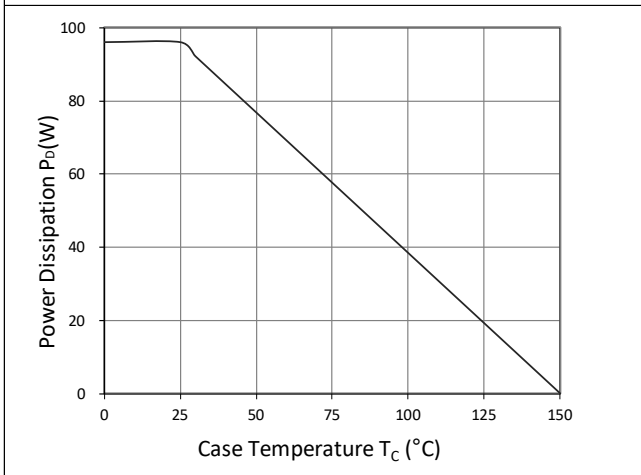


Figure 9. Power Dissipation

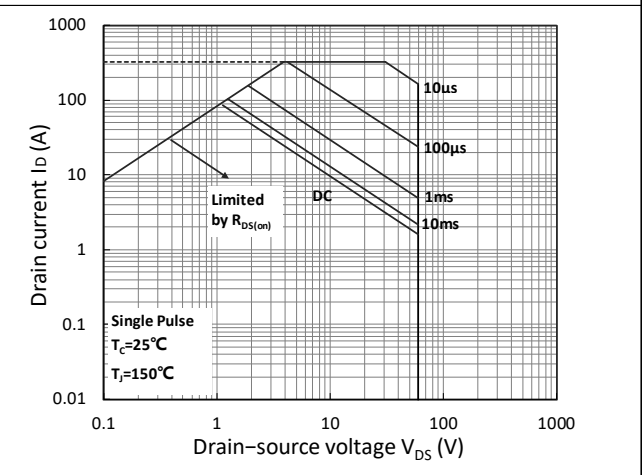


Figure 10. Safe Operating Area

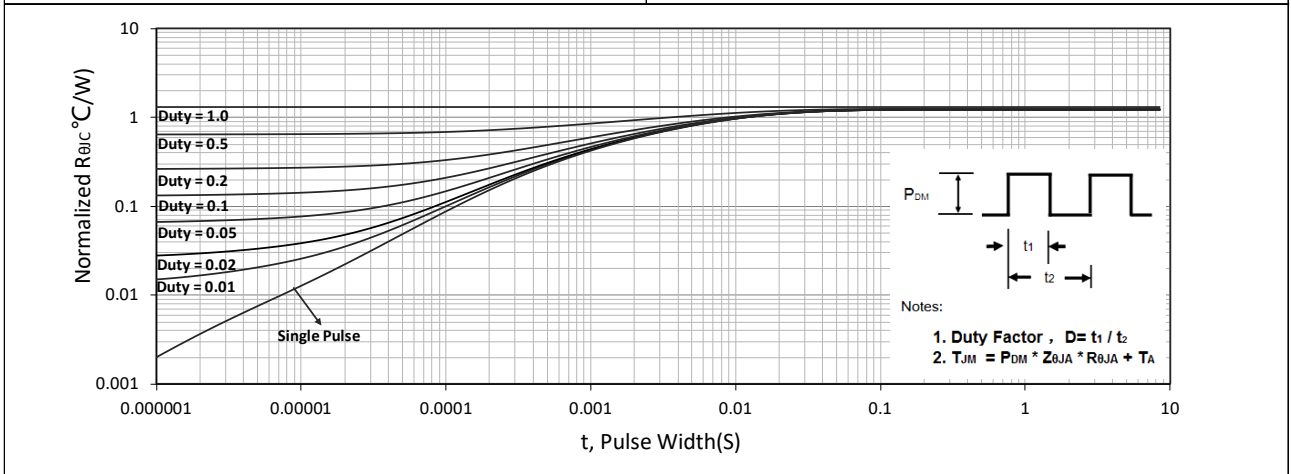


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

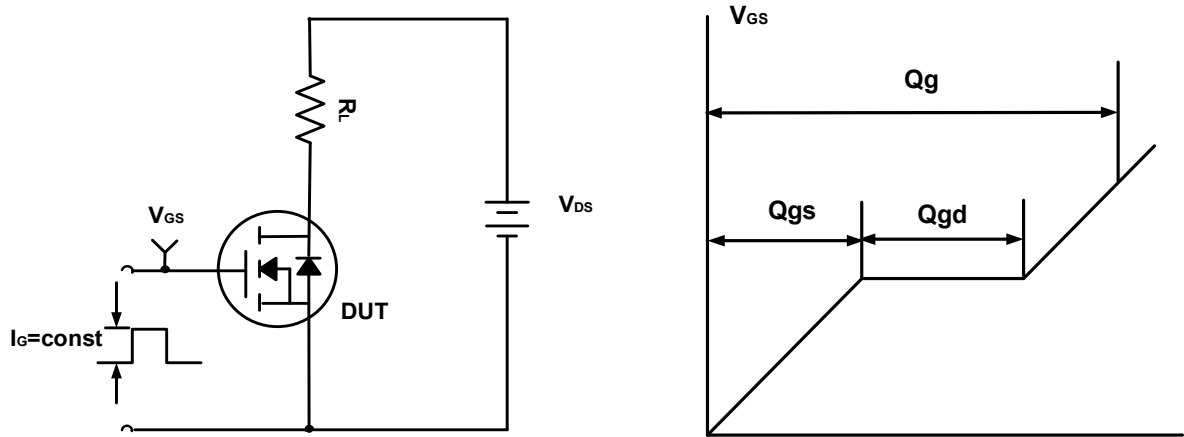


Figure A. Gate Charge Test Circuit & Waveforms

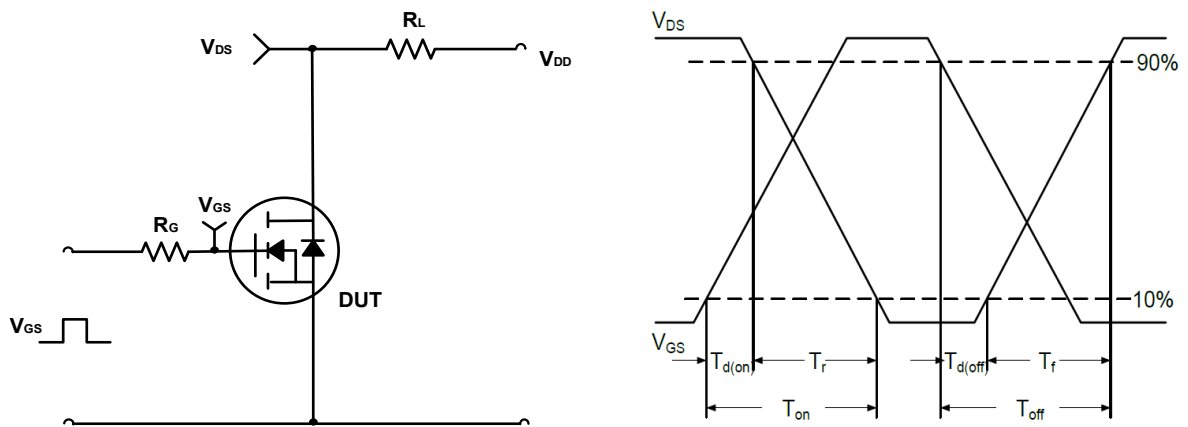


Figure B. Switching Test Circuit & Waveforms

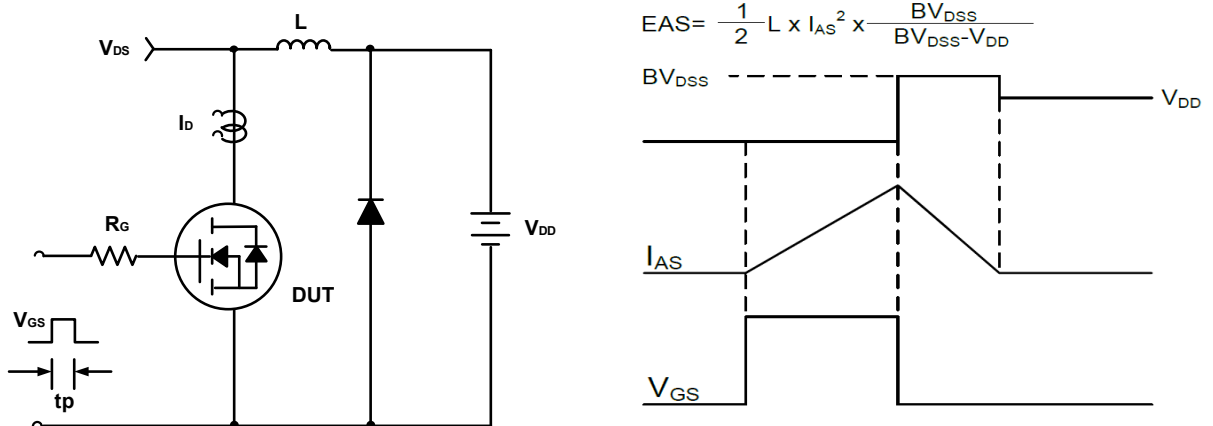
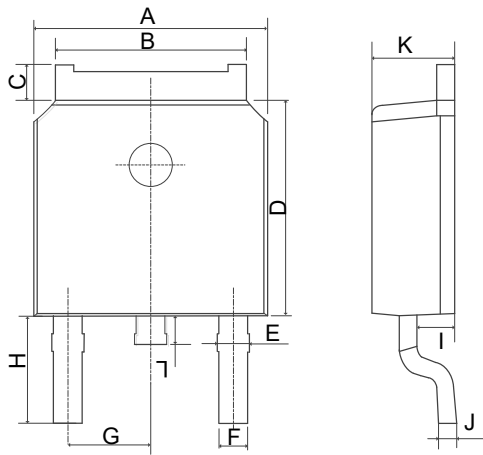


Figure C. Unclamped Inductive Switching Circuit & Waveforms

## Mechanical Dimensions for TO-252



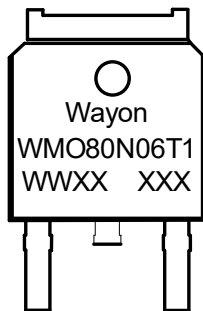
## COMMON DIMENSIONS

SYMBOL	MM	
	MIN	MAX
A	6.40	6.80
B	5.13	5.50
C	0.88	1.28
D	5.90	6.22
E	0.68	1.10
F	0.68	0.91
G	2.29REF	
H	2.90REF	
I	0.85	1.17
J	0.51REF	
K	2.10	2.50
L	0.40	1.00

## Ordering Information

Part	Package	Marking	Packing method
WMO80N06T1	TO-252	WMO80N06T1	Tape and Reel

## Marking Information



WMO80N06T1 = Device code

WWXX XXX= Date code


## Contact Information

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